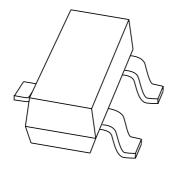
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS8110T 100 V, 1 A NPN low V_{CEsat} (BISS) transistor

Product specification Supersedes data of 2003 Jul 28

2003 Dec 22





100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

FEATURES

- SOT23 package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Major application segments
 - Automotive 42 V power
 - Telecom infrastructure
 - Industrial
- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- · Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT23 plastic package. PNP complement: PBSS9110T.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS8110T	*U8

Note

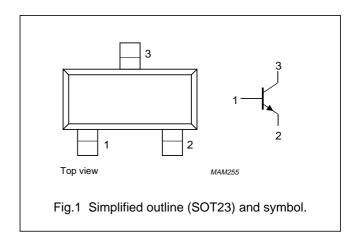
* = p : Made in Hong Kong.
 * = t : Made in Malaysia.
 * = W : Made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	100	V
I _C	collector current (DC)	1	Α
I _{CM}	repetitive peak collector current	3	А
R _{CEsat}	equivalent on-resistance	200	mΩ

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
ITPE NOWIDER	NAME DESCRIPTION VERSION			
PBSS8110T	_	plastic surface mounted package; 3 leads SO		

100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

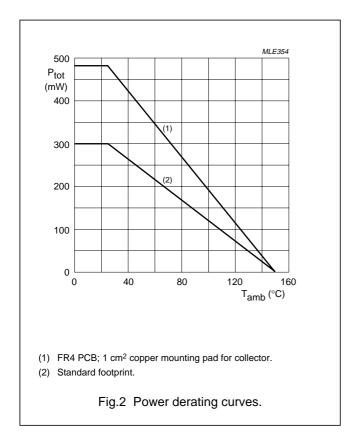
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	120	٧
V _{CEO}	collector-emitter voltage	open base	_	100	V
V _{EBO}	emitter-base voltage	open collector	_	5	٧
I _C	collector current (DC)		_	1	Α
I _{CM}	peak collector current	limited by T _{j max}	_	3	Α
I _B	base current (DC)		_	300	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	300	mW
		T _{amb} ≤ 25 °C; note 2	_	480	mW
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated, standard footprint.
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 1 cm².



100 V, 1 A NPN low V_{CEsat} (BISS) transistor

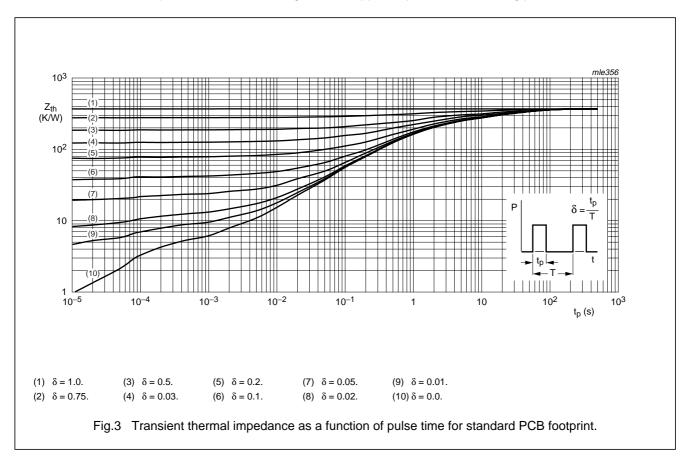
PBSS8110T

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to	in free air; note 1	417	K/W
	ambient	in free air; note 2	260	K/W

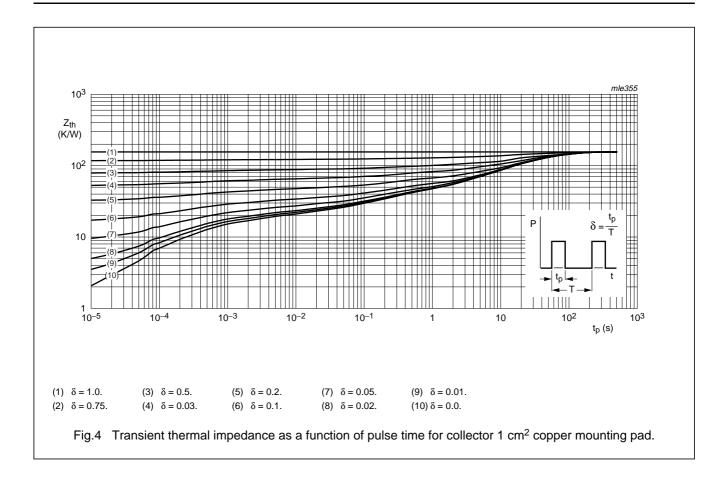
Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and standard footprint.
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm².



100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T



100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

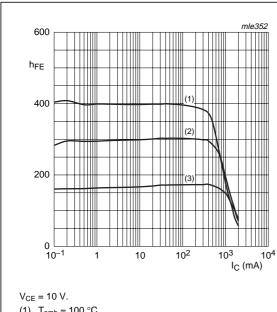
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 80 V; I _E = 0	_	_	100	nA
		V _{CB} = 80 V; I _E = 0; T _j = 150 °C	_	_	50	μΑ
I _{CES}	collector-emitter cut-off current	V _{CE} = 80 V; V _{BE} = 0	_	_	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 4 V; I _C = 0	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 10 V; I _C = 1 mA	150	_	_	
		V _{CE} = 10 V; I _C = 250 mA	150	_	500	
		V _{CE} = 10 V; I _C = 500 mA; note 1	100	_	_	
		V _{CE} = 10 V; I _C = 1 A; note 1	80	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 10 mA	_	_	40	mV
		I _C = 500 mA; I _B = 50 mA	_	_	120	mV
		I _C = 1 A; I _B = 100 mA; note 1	_	_	200	mV
R _{CEsat}	equivalent on-resistance	I _C = 1 A; I _B = 100 mA; note 1	_	165	200	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	_	_	1.05	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 10 V; I _C = 1 A	_	_	0.9	V
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	7.5	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

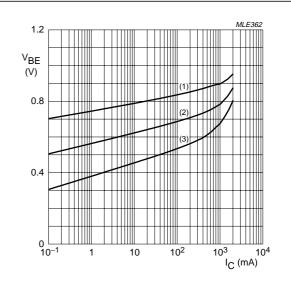
100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T



- (1) T_{amb} = 100 °C.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

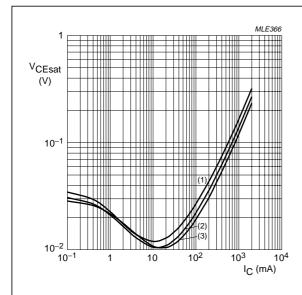
Fig.5 DC current gain as a function of collector current; typical values.



 $V_{CE} = 10 \text{ V}.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

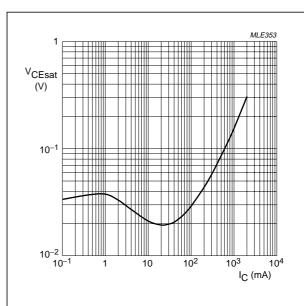
Fig.6 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = 100 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.7 Collector-emitter saturation voltage as a function of collector current; typical values.



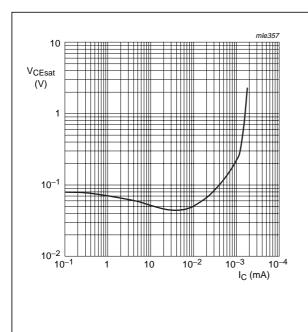
 $I_{\rm C}/I_{\rm B} = 20.$ T_{amb} = 25 °C.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.

7 2003 Dec 22

100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

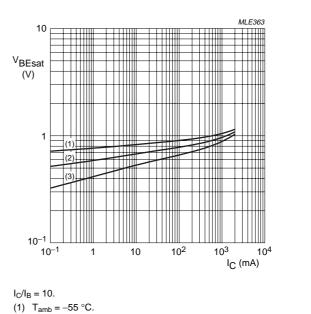


 $I_C/I_B = 50$. $T_{amb} = 25 \,^{\circ}C$.

 $I_{\rm C}/I_{\rm B} = 20.$

 $T_{amb} = 25 \, ^{\circ}C.$

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.



(1) $T_{amb} = -55 \,^{\circ}\text{C}$. (2) $T_{amb} = 25 \,^{\circ}\text{C}$. (3) $T_{amb} = 100 \,^{\circ}\text{C}$.

Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.

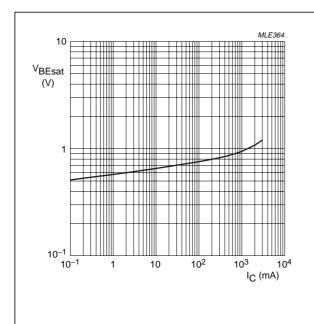


Fig.11 Base-emitter saturation voltage as a function of collector current; typical values.

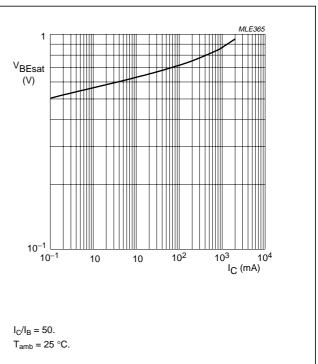


Fig.12 Base-emitter saturation voltage as a function of collector current; typical values.

100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

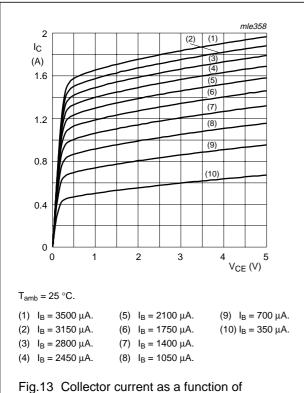


Fig.13 Collector current as a function of collector-emitter voltage; typical values.

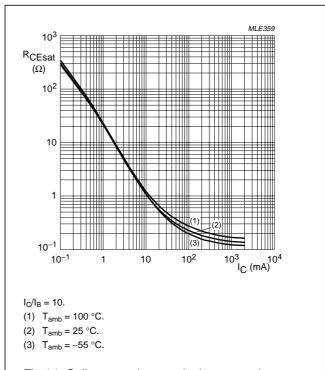


Fig.14 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

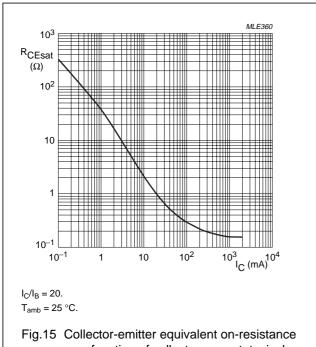
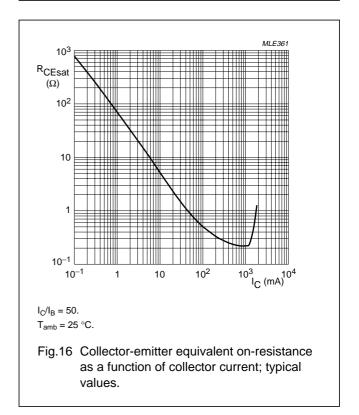


Fig.15 Collector-emitter equivalent on-resistance as a function of collector current; typical values.



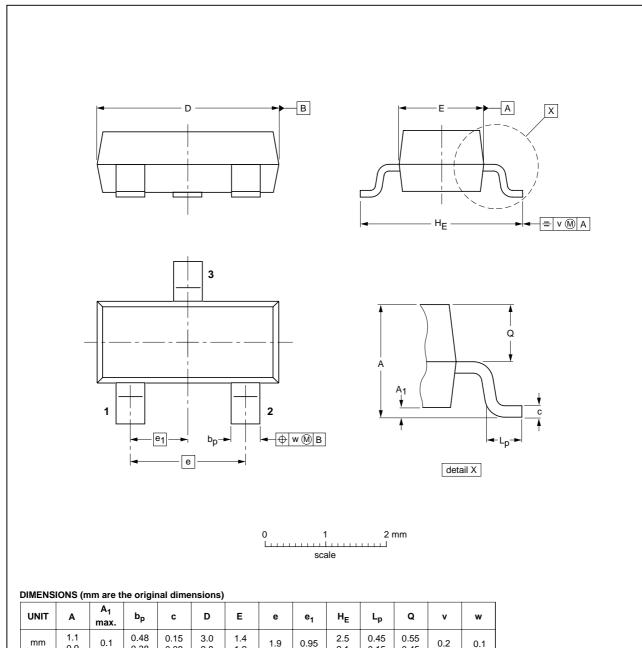
100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC JEDEC EIAJ			PROJECTION	ISSUE DATE	
SOT23		TO-236AB				97-02-28 99-09-13

2003 Dec 22 10

0.9

100 V, 1 A NPN low V_{CEsat} (BISS) transistor

PBSS8110T

DATA SHEET STATUS

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